SD103AW THRU SD103CW

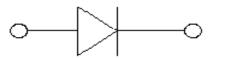


Small Signal Schottky Diode

Features

- 40V/30V/20V • V_R
- IFAV 350mA

• Package: SOD123



Mechanical Data

- Terminals: Tin plated leads, solderable per
- J-STD-002 and JESD22-B102
- Polarity: Cathode line denotes the cathode end

	Marking
SD103AW	S4
SD103BW	S5
SD103CW	S6

■Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Conditions	VALUE	
				SD103AW	40
Reverse voltage	Reverse voltage V _R V I _R =100uA	V	I _R =100uA	SD103BW	30
			SD103CW	20	
Peak forward surge current	I _{FSM}	A	t_p =8.3ms, half sine	1.5	
Average forward current	I _{FAV}	A	T₀=25°C	0.35	
Power dissipation	P _D	mW		400	
Maximum junction temperature	Tj	°C		-55 to +125	
Storage temperature range	T _{stg}	°C		-55 to +150	
Thermal Resistance Junction to Ambient Air	$R_{ ext{ hetaJA}}$	°C /W		315	

■Electrical Characteristics (Ta=25°C Unless otherwise specified)

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PARAMETER	SYMBOL	UNIT	Conditions		VALUE		
Mariana	V _F	V	I _F =20mA, T _A =25°C I _F =200mA, T _A =25°C		I _F =20mA, T _A =25°C 0.37		37
Maximum Forward voltage	V _F	V			0.60		
			SD103AW	V _R =30V,T _A =25°C			
Maximum Reverse current	I _R	uA	SD103BW	V _R =20V,T _A =25°C	5.0		
			SD103CW	V _R =10V,T _A =25°C			
		v	I _R =100uA		SD103AW	40	
Minimum Breakdown voltage	V _(BR)				SD103BW	30	
					SD103CW	20	
Typical Junction capacitance	CJ	pF	$V_R=0V$, f=1MHz		V _R =0V, f =1MH _z 50		0

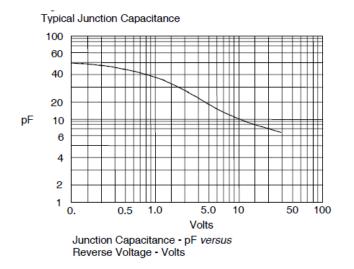
■Ordering Information (Example)

PREFERED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
SD103AW THRU SD103CW	F2	Approximate 0.011	3000	30000	120000	7" reel

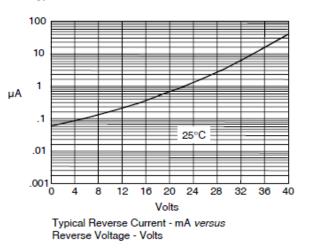


SD103AW THRU SD103CW

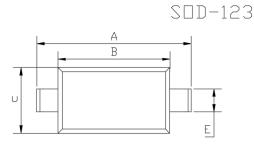
Characteristics (Typical)



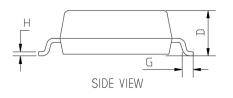
Typical Reverse Characteristics

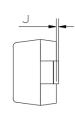


Outline Dimensions



TOP VIEW

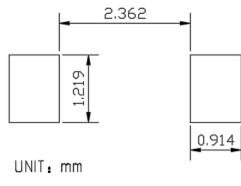




SIDE VIEW

		DIMENSIONS			
МІД	INC	HES	ММ		
	MIN	MAX	MN	MAX	
А	0.140	0.152	3.550	3.850	
В	0.100	0.112	2.550	2.850	
С	0.055	0.071	1.400	1.800	
D	0.037	0.053	0.950	1.350	
E	0.020	0.028	0.510	0.710	
G	0.006		0.150		
н		0.010		0.250	
J		0.006		0.150	

Soldering Footprint



SUGGESTED SOLDER PAD LAYOUT



SD103AW THRU SD103CW

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